

Title (en)

MOLD COMPOSITION COMPRISING A SUGAR COMPONENT

Title (de)

FORMZUSAMMENSETZUNG UMFASSEND EINE ZUCKERKOMPONENTE

Title (fr)

COMPOSITION À MOULER COMPRENANT UN COMPOSANT À BASE DE SUCRE

Publication

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Application

**EP 19831731 A 20191220**

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Abstract (en)

[origin: WO2020127980A1] The invention relates to a mold composition comprising at least one sugar component in a weight proportion of at least 20% in relation to the weight of the mold composition and at least one loading material, and to a mold for a molding method, the mold being a compact three-dimensional structure which consists of the mold composition. The invention also relates to a method for molding a workpiece by means of said mold.

IPC 8 full level

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